

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, emplo



May 2015

S3A - S3N General-Purpose Rectifiers

Features

- · Low-Profile Package
- · Glass-Passivated Junction
- UL Flammability Classification: 94V-0
- UL Certified, UL #E258596



Ordering Informations

Part Number	Top Mark	Package	Packing Method		
S3A	S3A	DO-214AB (SMC)	Tape and Reel		
S3B	S3B	DO-214AB (SMC)	Tape and Reel		
S3D	S3D	DO-214AB (SMC)	Tape and Reel		
S3G	S3G	DO-214AB (SMC)	Tape and Reel		
S3J	S3J	DO-214AB (SMC)	Tape and Reel		
S3K	S3K	DO-214AB (SMC)	Tape and Reel		
S3M	S3M	DO-214AB (SMC)	Tape and Reel		
S3N	S3N	DO-214AB (SMC) Tape and Reel			

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

Symbol	Parameter		Value							
Symbol			S3B	S3D	S3G	S3J	S3K	S3M	S3N	Unit
V_{RRM}	Maximum Repetitive Reverse Voltage		100	200	400	600	800	1000	1200	V
I _{F(AV)}	Average Rectified Forward Current T _L = 105°C		3.0							Α
I _{FSM}	Non-Repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave		100							Α
T _{STG}	Storage Temperature Range		-55 to +150							°C
TJ	Operating Junction Temperature Range		-55 to +150							°C

Thermal Characteristics(1)

Symbol	Parameter	Value	Unit
P _D	Power Dissipation	2.6	W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	100	°C/W
$R_{\theta JL}$	Thermal Resistance, Junction-to-Lead	13	°C/W

Note:

1. Device is mounted on FR-4 PCB 0.013 mm. Land pattern size: refer to the package drawing. Trace size: force line = 50 mil & sense line = 4 mil.

Electrical Characteristics

Values are at $T_A = 25$ °C unless otherwise noted.

Symbol	Parameter	Conditions	Value							Unit	
Syllibol	Symbol Farameter		S3A	S3B	S3D	S3G	S3J	S3K	S3M	S3N	Oilit
V_{F}	Maximum Forward Voltage	$I_F = 3.0 \text{ A}$				1	.2				V
t _{rr}	Maximum Reverse Recovery Time			μs							
I_	Maximum Reverse Current	T _A = 25°C				;	5				μA
I _R	at rated V _R		250							μΑ	
C _T	Typical Total Capacitance	V _R = 4.0 V, f = 1.0 MHz	60			pF					

Typical Performance Characteristics

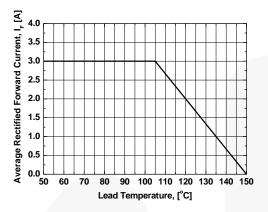


Figure 1. Forward Current Derating Curve

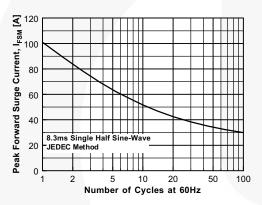


Figure 3. Non-Repetitive Surge Current

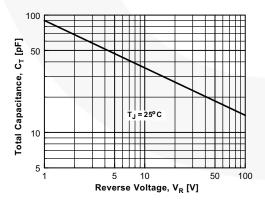


Figure 5. Total Capacitance

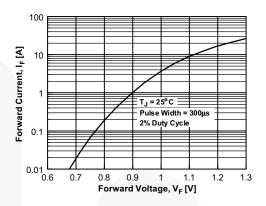


Figure 2. Forward Voltage Characteristics

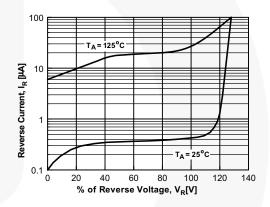
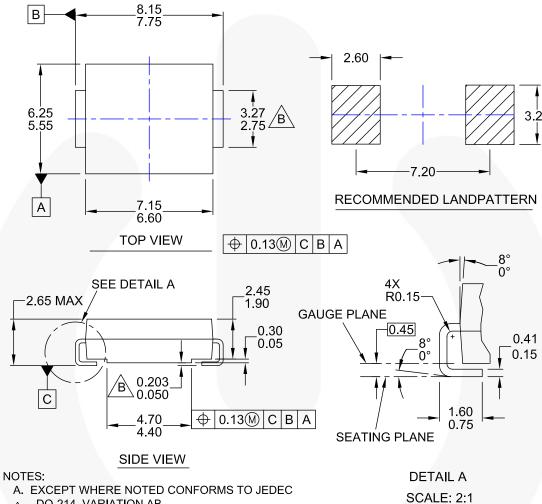


Figure 4. Reverse Current vs. Reverse Voltage

Physical Dimensions



A. EXCEPT WHERE NOTED CONFORMS TO JEDEC DO-214, VARIATION AB.

DOES NOT COMPLY TO JEDEC STD. VALUE.

- C. ALL DIMENSIONS ARE IN MILLIMETERS. D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD
- FLASH, AND TIE BAR PROTRUSIONS.
- E. DIMENSIONS AND TOLERANCING AS PER ASME Y14.5M-1994
- F. LAND PATTERN STANDARD: DIOM7957X241M
- G. DRAWING FILE NAME: DO214ABREV1

Figure 6. 2-Lead, SMC, JEDEC DO-214, Variation AB





TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

 BitSiC™
 Green FPS™

 Build it Now™
 Green FPS™ e-Series™

CorePLUSTM $Gmax^{TM}$ CorePOWERTM GTO^{TM} $CROSSVOLT^{TM}$ IntelliMAXTM
CTLTM ISOPI ANARTM

Current Transfer Logic™ Making Small Speakers Sound Louder DEUXPEED® and Better™

Dual Cool™

EcoSPARK®

EfficientMax™

ESBC™

MicroPak™

MicroPak™

MicroPak™

MicroPak™

MillerDrive™ Fairchild® MotionMax™ Fairchild Semiconductor® MotionGrid® FACT Quiet Series™ MTi[®] FACT® FAST® MTx® MVN® FastvCore™ mWSaver® FETBench™ OptoHiT™ **FPSTM** OPTOLOGIC® OPTOPLANAR®

Power Supply WebDesigner™

PowerTrench® PowerXS™

Programmable Active Droop™

QFET®
QS™
Quiet Series™
RapidConfigure™

Saving our world, 1mW/W/kW at a time™

SignalWise™ SmartMax™ SMART START™

Solutions for Your Success™

SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™

SYSTEM GENERAL®*

TinyBoost®
TinyBuck®
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™
TriFault Detect™

TriFault Detect™
TRUECURRENT®*
µSerDes™

SerDes**
UHC®
Ultra FRFET™

UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™
Xsens™
仙童™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT http://www.fairchildsemi.com, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN, NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Definition of Terms							
Datasheet Identification		Definition					
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.					
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.					
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.					
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.					

Rev. 174